Power MOSFET 8.5 A, 20 V, Logic Level, N–Channel Micro8[™] Leadless

EZFETsTM are an advanced series of Power MOSFETs which contain monolithic back-to-back zener diodes. These zener diodes provide protection against ESD and unexpected transients. These miniature surface mount MOSFETs feature ultra low $R_{DS(on)}$ and true logic level performance. EZFET devices are designed for use in low voltage, high speed switching applications where power efficiency is important. Typical applications are dc-dc converters, and power management in portable and battery powered products such as computers, printers, cellular and cordless phones.

Applications

- Zener Protected Gates Provide Electrostatic Discharge Protection
- Designed to Withstand 4000 V Human Body Model
- Ultra Low R_{DS(on)} Provides Higher Efficiency and Extends Battery Life
- Logic Level Gate Drive Can be Driven by Logic ICs
- Micro8 Leadless Surface Mount Package Saves Board Space
- I_{DSS} Specified at Elevated Temperature
- Pb–Free Package is Available*

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	10 Secs	Steady State	Unit
Drain-to-Source Voltage	V _{DSS}	2	0	V
Gate-to-Source Voltage	V _{GS}	±12		V
Continuous Drain Current (Note 1) $T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$	۱ _D	8.5 6.1	6.0 4.2	A
Pulsed Drain Current (tp $\leq 600 \mu$ s)	I _{DM}	3	0	A
Continuous Source–Diode Conduction (Note 1)	۱ _s	2.9	1.4	A
Total Power Dissipation (Note 1) $T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$	P _D	3.1 1.6	1.5 0.79	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	–55 t	o 150	°C
Thermal Resistance (Note 1) Junction-to-Ambient	R_{\thetaJA}	40	82	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. When surface mounted to 1" x 1" FR-4 board.

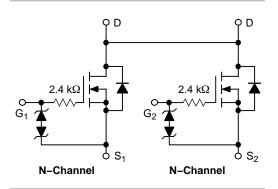
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

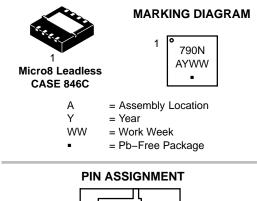


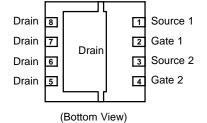
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V _{(BR)DSS}	R _{DS(on)} TYP	I _D MAX	
20 V	20 mΩ @ 4.5 V	√ 8.5 A	
20 V	22 mΩ @ 2.5 V	0.5 A	







ORDERING INFORMATION

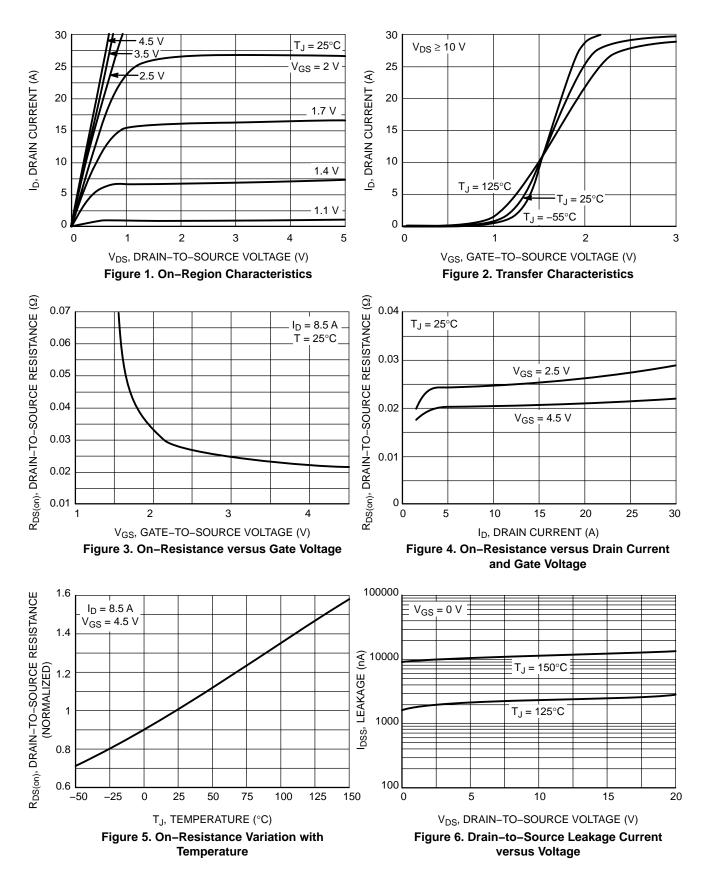
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

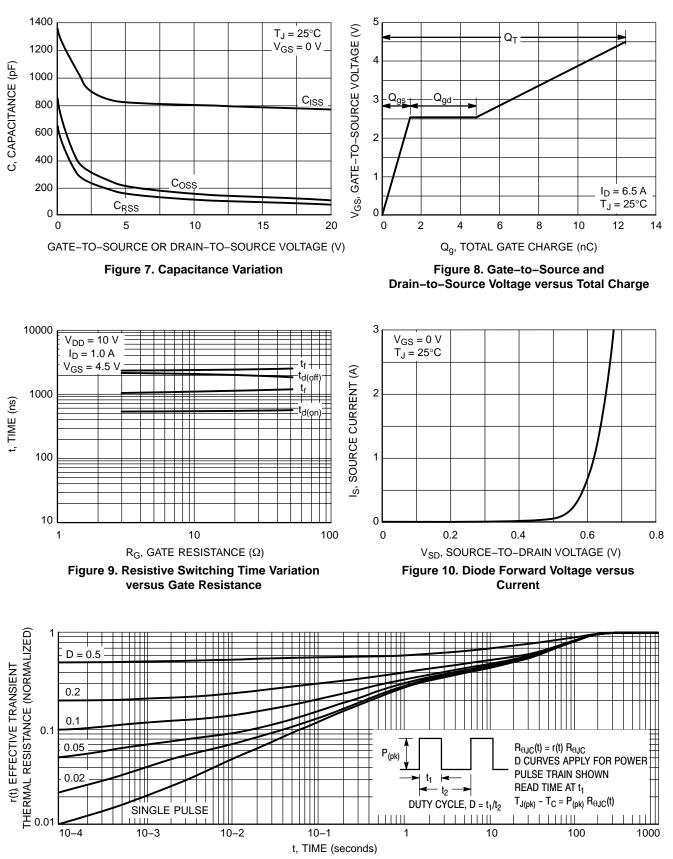
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		·	-		•	
Drain-to-Source Breakdown Voltage ($V_{GS} = 0$ Vdc, $I_D = 250 \mu Adc$)	e (Note 2)	V _{(BR)DSS}	20	_	_	Vdc
Zero Gate Voltage Drain Current (V_{DS} = 16 Vdc, V_{GS} = 0 Vdc) (V_{DS} = 16 Vdc, V_{GS} = 0 Vdc, T_J =	= 85°C)	I _{DSS}	-		1.0 20	μAdc
$ \begin{array}{l} \mbox{Gate-Body Leakage Current} \\ (\mbox{V}_{GS}=\pm 4.5 \mbox{ Vdc}, \mbox{V}_{DS}=0 \mbox{ Vdc}) \\ (\mbox{V}_{GS}=\pm 12 \mbox{ Vdc}, \mbox{V}_{DS}=0 \mbox{ Vdc}) \end{array} $		I _{GSS}	_		1.0 500	μAdc
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage (Note 2) $(V_{DS} = V_{GS}, I_D = 250 \ \mu \text{Adc})$		V _{GS(th)}	0.4	_	0.9	Vdc
$ Static Drain-to-Source On-Resistar \\ (V_{GS} = 4.5 \ Vdc, \ I_D = 6.5 \ Adc) \\ (V_{GS} = 2.5 \ Vdc, \ I_D = 5.8 \ Adc) $	nce (Note 2)	R _{DS(on)}		20 22	26 31	mΩ
DYNAMIC CHARACTERISTICS				·		
Input Capacitance		C _{iss}	-	785	-	pF
Output Capacitance	$(V_{DS} = 16 \text{ Vdc}, V_{GS} = 0 \text{ V}, f = 10 \text{ kHz})$	C _{oss}	-	135	-	
Transfer Capacitance	- ,	C _{rss}	-	100	-	
SWITCHING CHARACTERISTICS (Note 3)					
Gate Charge	(V _{GS} = 4.5 Vdc, I _D = 6.5 Adc,	Q _T	-	12.4	16	nC
(VGS	$V_{DS} = 10$ Vdc)	Q ₁	-	1.3	-]
	(Note 2)	Q ₂	-	3.5	-	
Turn-On Delay Time		t _{d(on)}	-	0.55	1.1	μs
Rise Time	$(V_{GS} = 4.5 \text{ Vdc}, V_{DD} = 10 \text{ Vdc},$	t _r	-	1.17	2.2	
Turn-Off Delay Time	$I_D = 1.0 \text{ Adc}, R_G = 9.1 \Omega$ (Note 2)	t _{d(off)}	-	2.9	5.8	
Fall Time		t _f	-	3.8	7.7	
SOURCE-DRAIN DIODE CHARAC	TERISTICS					
Forward On–Voltage	$(I_{S} = 1.5 \text{ Adc}, V_{GS} = 0 \text{ Vdc})$ $I_{S} = 1.5 \text{ Adc}, V_{GS} = 0 \text{ Vdc}, T_{J} = 85^{\circ}\text{C})$ (Note 2)	V _{SD}		0.65 0.60	1.0 _	Vdc
	(Note 2)					

Pulse Test: Pulse Width • 300 μs, Duty Cycle • 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL ELECTRICAL CHARACTERISTICS





TYPICAL ELECTRICAL CHARACTERISTICS

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Figure 11. Thermal Response

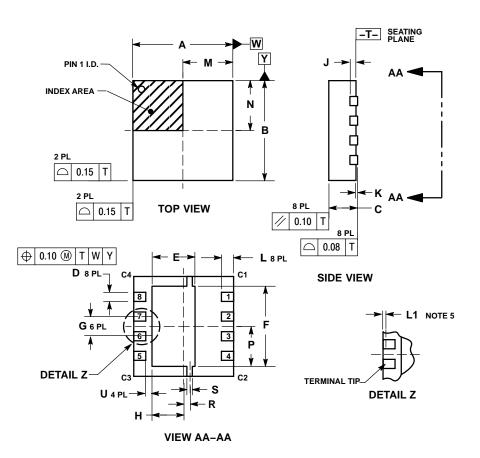
ORDERING INFORMATION

Device	Package	Shipping [†]
NTLTD7900NR2G	Micro8 LL (Pb–Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

Micro8 Leadless CASE 846C-01 ISSUE O



NOTES: 1. DIMENSIONS AND TOLERANCING PER ASME V14 5M 1004

- Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETER. 3. THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM
- TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE. 4. DIMENSION D APPUES TO METALUIZED
- 4. DIMENSION D APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 MM AND 0.30 MM FROM TERMINAL TIP. DIMENSION 1.15 THE TERMINAL PULL BACK FROM PACKAGE EDGE, UP TO 0.1 MM IS ACCEPTABLE. L1 IS OPTIONAL
- 5. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

	MILLIMETERS			
DIM	MIN	MAX		
Α	3.20	3.40		
В	3.20	3.40		
С	0.85	0.95		
D	0.28	0.33		
Е	1.30	1.50		
F	2.55	2.75		
G	0.65	0.65 BSC		
Н	0.95	1.15		
J	0.25 BSC			
Κ	0.00	0.05		
L	0.35	0.45		
М	1.60	1.70		
Ν	1.60	1.70		
Ρ	1.28	1.38		
R	0.200	0.250		
S	0.18	0.23		
U	0.20			

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